

MATERIALS

HOUSING: HI-TEMP. PLASTIC (UL 94V-0)
 SHELL: STAINLESS STEEL, NICKEL PLATING
 SOLDER PAD: STAINLESS STEEL, GOLD FLASH
 TERMINAL: COPPER ALLOY, GOLD PLATING

SPECIFICATION

CURRENT RATING: 0.5 AMP MAX
 DIELECTRIC WITHSTANDING: 500V AC FOR ONE MINUTE
 CONTACT RESISTANCE: 100m OHMS MAX
 INSULATION RESISTANCE: 1000M OHMS MIN AT DC 500V
 OPERATION TEMPERATURE: -40°C~+85°C

PART NUMBER:

4MCRB - 0 6 * - 1 2 6

SERIES

NO. OF POS.

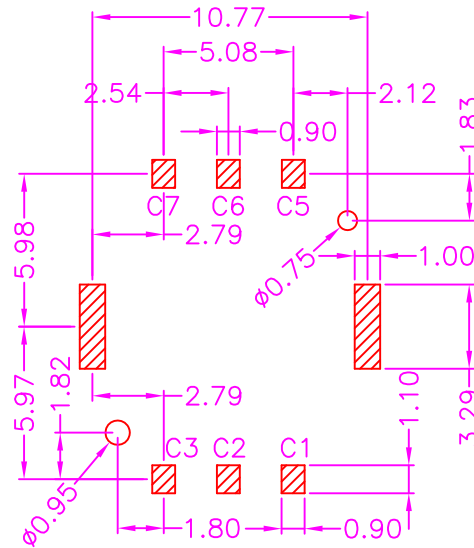
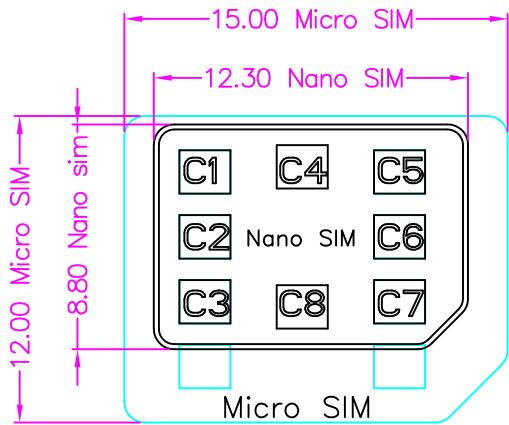
TAPE REEL PACKAGE

CONTACT PLATED OPTION

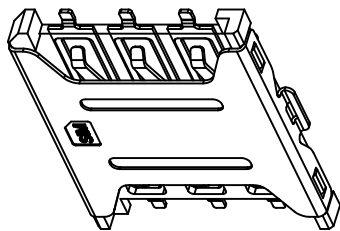
- 1: GOLD FLASH
- 3: 3u" GOLD
- 5: 5u" GOLD
- 6: 10u" GOLD
- 7: 15u" GOLD
- 9: 30u" GOLD
- 13: 8u" GOLD

A	RELEASE	2016.4.15
REV.	DESCRIPTION	DATE

Cyberconn Technology Co., Ltd. www.cyberconn.com.tw Tel:+886-3-4951314						
TOLERANCES X.X ±0.3 X.XX ±0.2 X.XXX ±0.1 Angle ±5°		MEMORY CARD SERIES NANO SIM CARD, 6PIN, PCB MOUNT, SMT METAL SHIELD, FEMALE, H=1.35mm				
		DRAWN BY		CHECKED BY		APPROVED BY
		Tina		Lion		Benson
UNIT	SCALE	SIZE	DRAW NO.	REV.	Sheet	
10184	MM	NONE	A4	4MCRB-006	A	1/2



P.C.B LAYOUT
TOP VIEW ± 0.05



SIM pin assignment	
PIN	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

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TOLERANCES	MEMORY CARD SERIES				
X.X ± 0.3	NANO SIM CARD, 6PIN, PCB MOUNT, SMT				
X.XX ± 0.2	METAL SHIELD, FEMALE, H=1.35mm				
X.XXX ± 0.1	DRAWN BY	CHECKED BY	APPROVED BY		
Angle $\pm 5^\circ$	<i>Tina</i>	<i>Lion</i>	<i>Benson</i>		
	UNIT	SCALE	SIZE	DRAW NO.	REV.
	MM	NONE	A4	4MCRB-006	A
					Sheet
					2/2

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